INDIAN INSTITUTE OF TECHNOLOGY, BOMBAY

Sophisticated Analytical Instrument Facility (SAIF)

Focused Ion Beam - Scanning Electron Microscope (FIB-SEM)

NOTE:

PART A : To be filled if user requires FIB Milling, patterning / TEM sample preparation / 3D Slice & View PART B : To be filled if user requires SEM imaging & EDS Analysis

PART A

Request Form for **FIB Analysis** for internal IITB users (Details required for FIB Milling, patterning / TEM sample preparation / 3D Slice & View)

Applicant Details:

User Name:	
Email ID:	Mobile No.:
Name of Guide/PI:	
Guide/PI Email ID:	Guide/PI Mobile No.:

Sample information :

Number of samples	
Sample code	
Sample Composition	
&	
Sample dimensions	
(The sample size should be	
less than 10 mm x 10 mm x	
4mm and base of the	
sample should be flat for	
mounting on sample holder)	
** Sample Height/	
Thickness should not	
exceed 4mm)	
Analysis Required (Tick the relevant analysis required)	FIB Milling / TEM sample preparation / 3D Slice & View
	If FIB Milling / 3D Slice & View is ticked then, What feature

	size (estimated) are you looking to mill / image?
	If TEM sample preparation is ticked then, What are the dimensions required for TEM lamella?
	Any additional information
Sample type (you can select multiple options)	Powder (Not for Milling) / Solid / Solid but porous / Magnetic (Highly magnetic samples not possible) / Thin film / Other (Please specify)
Detailed description of the sample. (Briefly describe the method used to prepare or fabricate your sample before bring it for FIB related preparation)	
	Non-Conducting / Conducting / Semi-Conductor
	Magnetic /Non Magnetic
	Is it electron beam sensitive? Yes/No → (Explain if Yes)
	Is it volatile? Yes/No →
	Is it flammable? Yes/No →
Nature of the sample	Is the material loosely bound under vacuum condition? (Yes/No) (Explain if Yes)
	 If YES 1. Has sticky tape test been done by the user in case of solid / thin film on substrate? (Yes/No) (Explain if No)
	 2. Has compressed gas blow test been done by the user in case powder on carbon tape? (Yes/No) (Explain if No)

Please explain your reason	
behind preferring FIB	
(Milling / Cross section	
imaging / TEM lamella	
preparation) over other	
characterisation tools for	
sample preparation	
(Maximum 50 words)	
Have you prepared lamella	
using FIB earlier? If Yes,	
please provide details of	
preparation method and	
sample dimensions	
If No, then in case of TEM	
Lamella preparation,	
Request user to attach a ppt	
(please prepare a PPT	
describing your sample	
detail. Make a diagram	
describing the details	
requires for lamella	
preparation.)	
Is site specific sample	
preparation mandatory? If	
so, mention the specific	
area in the sample.	
(Publication related to this	
work would help):	
Note:	
	hat may be helpful for sample preparation and analysis
 Samples for FIB related preparations should be well-polished / Uniform 	
 The sample size should be less than 10 mm x 10 mm x 4 mm (height) in case 	
of bulk samples and base of the sample should be flat for mounting on sample	
holder	suise of the sumple should be flut for mounting on sumple
nouci	

PART B

Request Form for **SEM-EDS Analysis** for internal IITB users (Details required for SEM & EDS Analysis)

Applicant Details :

User Name:		
Email ID:	Mobile No ·	

Name of Guide/PI:	
Guide/PI Email ID:	. Guide/PI Mobile No.:

Sample information:

Number of samples	
Sample code	
Sample type	Biological / Composite Material / Thin Film / Crystalline Solid / Metal/Polymer/Ceramic/Composite/ Other (Please specify): *biological samples should be submitted after primary fixation
Detailed description of	
the sample (Refer Annexure I before filling)	
Sample form	Powder/Pellet/Suspension/On glass substrate/Film/Others
If sample is Pellet, thin film (Refer Annexure II before filling)	Mention sample dimensions
If sample is powder,	Yes/No
Dispersion required (Refer	If Yes, Medium for
Annexure II before filling)	dispersion
Nature of the sample	Non-Conducting / Conducting / Semi-Conductor
Sample is	Magnetic /Non Magnetic

Type of Analysis & Details of the Analysis required (Kindly tick):

SEM Image	Mode	Secondary Electron Image / Back Scattered Electron Image
	Analysis requirement	Surface Imaging / Cross Section Imaging / Surface + Cross Section imaging (*For powder and suspension samples only surface imaging is possible*)
	Sample to be mounted	Planar/Cross Section/ Powder directly loaded on sample holder/ Drop cast for liquid or suspension samples
	Expected Morphology	Brief description about shape
	Expected Particle Size	
EDS	Analysis requirement	Point EDS /area EDS/EDS mapping/ line scan
	List of expected elements (for EDS)	
STEM Imaging		Please mention the sample thickness (Should be < 100 nm)
		Please mention the sample thickness (Should be < 100nm)